

The RF Line

NPN Silicon

RF Low Power Transistor

Designed primarily for wideband large signal predriver stages in the UHF frequency range.

- Specified @ 12.5 V, 470 MHz Characteristics @ $P_{out} = 1.5$ W
Common Emitter Power Gain = 12.5 dB (Typ)
Efficiency 60% (Typ)
- Cost Effective PowerMacro Package
- Electroless Tin Plated Leads for Improved Solderability
- Circuit board photomaster available upon request by contacting RF Tactical Marketing in Phoenix, AZ.

MRF555

**1.5 W, 470 MHz
RF LOW POWER
TRANSISTOR
NPN SILICON**



CASE 317D-02, STYLE 2

MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Collector-Emitter Voltage	V_{CEO}	16	Vdc
Collector-Base Voltage	V_{CBO}	36	Vdc
Emitter-Base Voltage	V_{EBO}	4.0	Vdc
Collector Current — Continuous	I_C	400	mAdc
Operating Junction Temperature	T_J	150	°C
Total Device Dissipation @ $T_C = 75^\circ\text{C}$ (1, 2) Derate above 75°C	P_D	3.0 40	Watts mW/°C
Storage Temperature Range	T_{stg}	-55 to +150	°C

THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Thermal Resistance, Junction to Case	$R_{\theta JC}$	25	°C/W

ELECTRICAL CHARACTERISTICS ($T_A = 25^\circ\text{C}$ unless otherwise noted)

Characteristic	Symbol	Min	Typ	Max	Unit
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OFF CHARACTERISTICS

Collector-Emitter Breakdown Voltage ($I_C = 5.0$ mAdc, $I_B = 0$)	$V_{(BR)CEO}$	16	—	—	Vdc
Collector-Emitter Breakdown Voltage ($I_C = 5.0$ mAdc, $V_{BE} = 0$)	$V_{(BR)CES}$	36	—	—	Vdc
Emitter-Base Breakdown Voltage ($I_E = 0.1$ mAdc, $I_C = 0$)	$V_{(BR)EBO}$	4.0	—	—	Vdc
Collector Cutoff Current ($V_{CE} = 15$ Vdc, $V_{BE} = 0$, $T_C = 25^\circ\text{C}$)	I_{CES}	—	—	0.1	mAdc

ON CHARACTERISTICS

DC Current Gain ($I_C = 100$ mAdc, $V_{CE} = 5.0$ Vdc)	h_{FE}	50	90	200	—
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DYNAMIC CHARACTERISTICS

Output Capacitance ($V_{CB} = 15$ Vdc, $I_E = 0$, $f = 1.0$ MHz)	C_{ob}	—	3.5	5.0	pF
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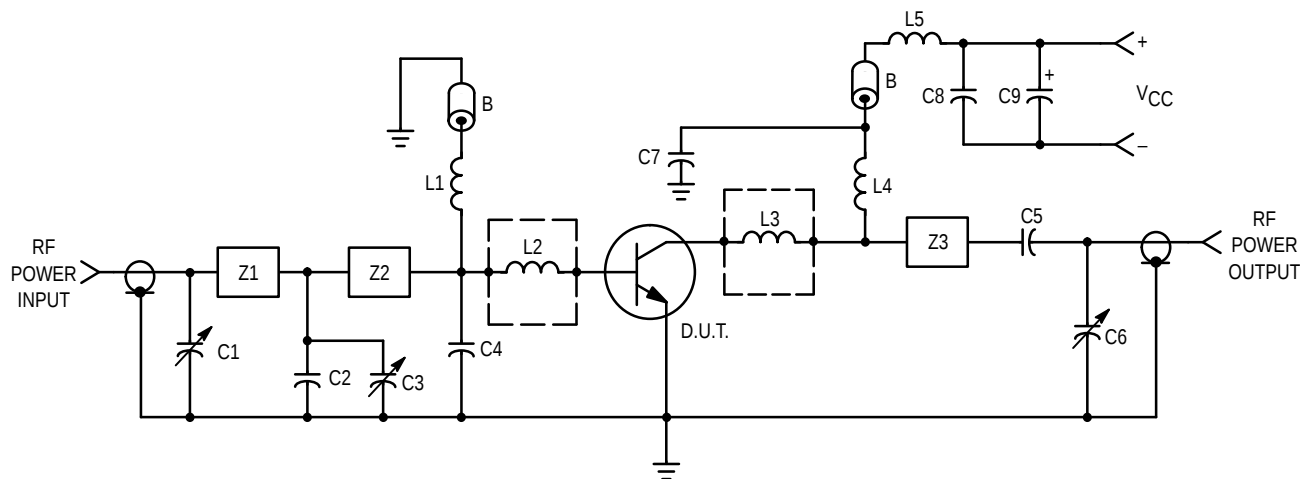
NOTES:

(continued)

- T_C , Case temperature measured on collector lead immediately adjacent to body of package.
- The MRF555 PowerMacro must be properly mounted for reliable operation. AN938, "Mounting Techniques in PowerMacro Transistor," discusses methods of mounting and heatsinking.

ELECTRICAL CHARACTERISTICS — continued ($T_A = 25^\circ\text{C}$ unless otherwise noted)

Characteristic	Symbol	Min	Typ	Max	Unit
FUNCTIONAL TESTS ($f = 470\text{ MHz}$)					
Common-Emitter Power Gain ($V_{CC} = 12.5\text{ Vdc}$, $P_{out} = 1.5\text{ W}$)	G_{pe}	11	12.5	—	dB
Collector Efficiency ($V_{CC} = 12.5\text{ Vdc}$, $P_{out} = 1.5\text{ W}$)	η_c	50	60	—	%
Load Mismatch Stress ($V_{CC} = 15.5\text{ Vdc}$, $P_{in} = 125\text{ mW}$, $VSWR \geq 10:1$ all phase angles)	ψ	No Degradation in Output Power			



*C1, C3, C6 — 0.8–11 pF Johanson
 C2 — 15 pF Clamped Mica, Mini-Underwood
 C4 — 36 pF Clamped Mica, Mini-Underwood
 C5 — 470 pF Ceramic Chip Capacitor
 C7 — 91 pF Clamped Mica, Mini-Underwood
 C8 — 68 pF Clamped Mica, Mini-Underwood
 C9 — 1.0 μF , 25 V Tantalum
 B — Bead, Ferroxcube 56–590–65/3B

*Fixed tuned for broadband response

L1 — 5 Turns #21 AWG, 5/32" I.D.
 L2, L3 — 60 x 125 x 250 Mils Copper Pad on 27 Mil Thick Alumina Substrate
 L4, L5 — 7 Turns #21 AWG 5/32" I.D.
 Z1 — 1.29" x 0.16" Microstrip
 Z2 — 0.70" x 0.16" Microstrip
 Z3 — 2.18" x 0.16" Microstrip
 PCB — 1/16" Glass Teflon, 1 oz. cu. clad, double sided, $\epsilon_r = 2.5$

Figure 1. 400–512 MHz Broadband Circuit

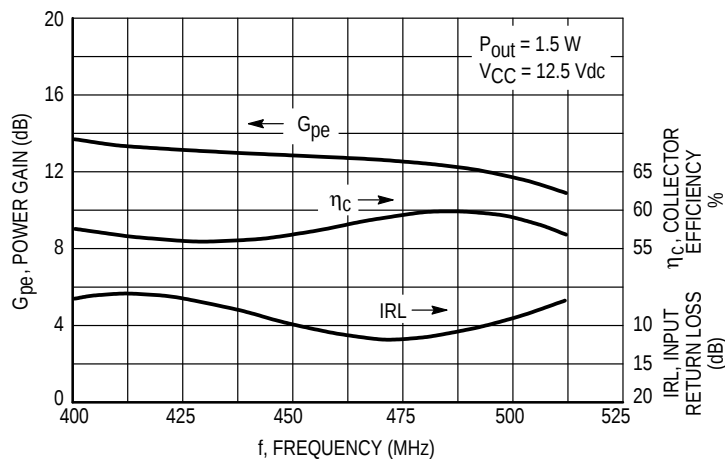


Figure 2. Performance in Broadband Circuit

f Frequency MHz	Z_{in} Ohms		Z_{OL}^* Ohms	
	$V_{CC} = 7.5\text{ V}$	$V_{CC} = 12.5\text{ V}$	$V_{CC} = 7.5\text{ V}$	$V_{CC} = 12.5\text{ V}$
	$P_{in} = 100\text{ mW}$	$P_{in} = 50\text{ mW}$	$P_{out}\text{ }400\text{ MHz} = 1.5\text{ W}$ $P_{out}\text{ }450\text{ MHz} = 1.35\text{ W}$ $P_{out}\text{ }512\text{ MHz} = 1.05\text{ W}$	$P_{out}\text{ }400\text{ MHz} = 1.9\text{ W}$ $P_{out}\text{ }450\text{ MHz} = 1.45\text{ W}$ $P_{out}\text{ }512\text{ MHz} = 0.9\text{ W}$
400	$2.9 - j2.7$	$1.9 - j3.1$	$18.0 - j13.4$	$12.2 - j19.7$
450	$2.2 - j0.8$	$2.6 - j4.0$	$21.6 - j9.9$	$20.2 - j18.6$
512	$3.5 - j1.2$	$2.6 - j2.6$	$20.1 - j1.0$	$23.4 - j23.0$

Z_{OL}^* = Conjugate of the optimum load impedance into which the device output operates at a given output power, voltage and frequency.

Table 1. Z_{in} and Z_{OL} versus Collector Voltage, Input Power and Output Power

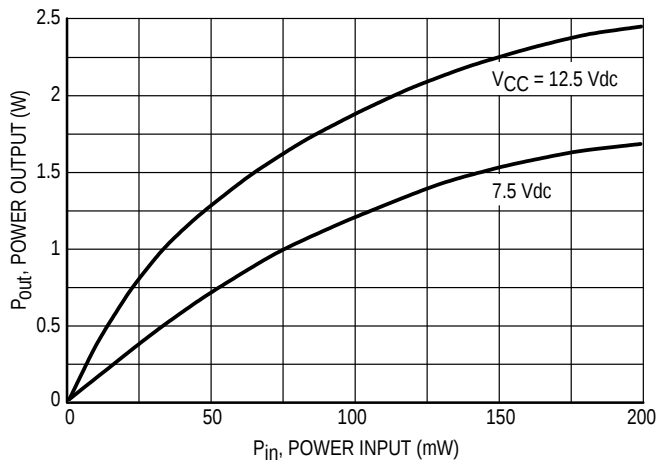


Figure 3. Power Output versus Power Input

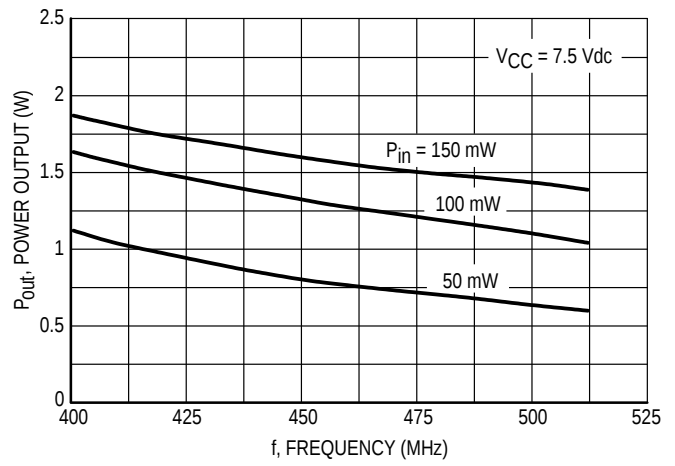


Figure 4. Power Output versus Frequency

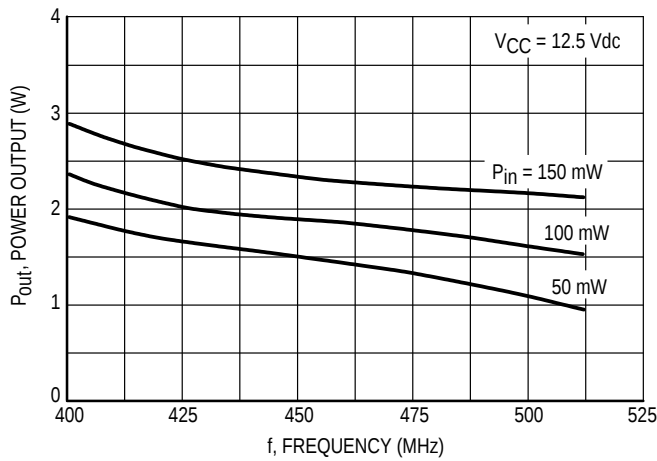


Figure 5. Power Output versus Frequency

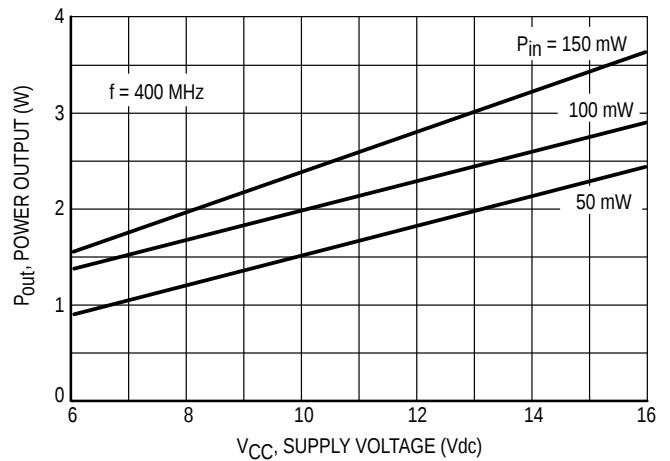


Figure 6. Power Output versus Supply Voltage

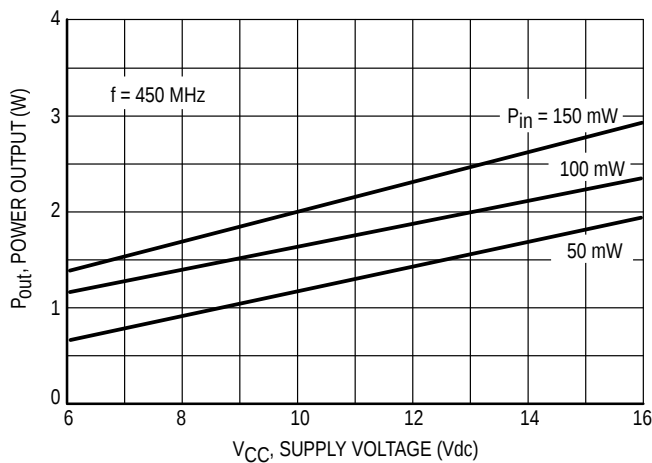


Figure 7. Power Output versus Supply Voltage

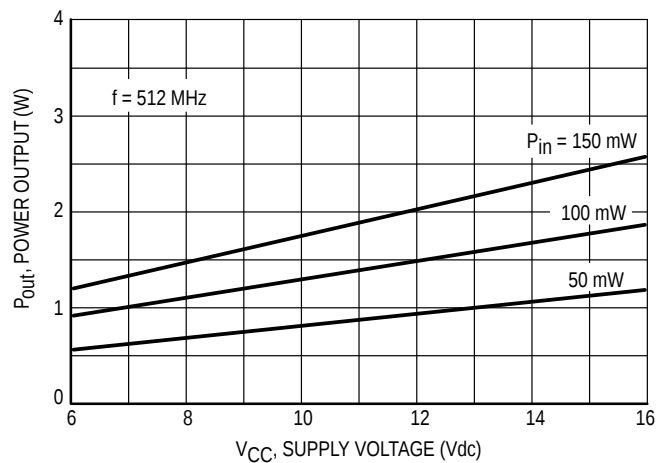
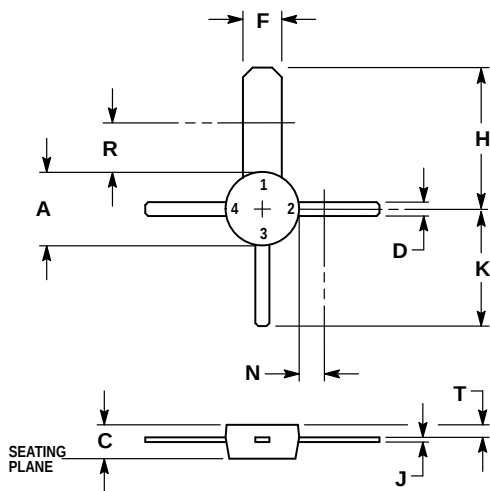


Figure 8. Power Output versus Supply Voltage

PACKAGE DIMENSIONS



- NOTES:
- 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
 - 2. CONTROLLING DIMENSION: INCH.
 - 3. LEAD DIMENSIONS UNCONTROLLED WITHIN DIMENSION N AND R.

DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	0.175	0.205	4.45	5.20
C	0.075	0.100	1.91	2.54
D	0.033	0.039	0.84	0.99
F	0.097	0.104	2.46	2.64
H	0.348	0.383	8.84	9.72
J	0.008	0.012	0.24	0.30
K	0.285	0.320	7.24	8.12
N	—	0.065	—	1.65
R	—	0.128	—	3.25
T	0.025	0.040	0.64	1.01

STYLE 2:
PIN 1. COLLECTOR
2. EMITTER
3. BASE
4. EMITTER

CASE 317D-02
ISSUE C

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